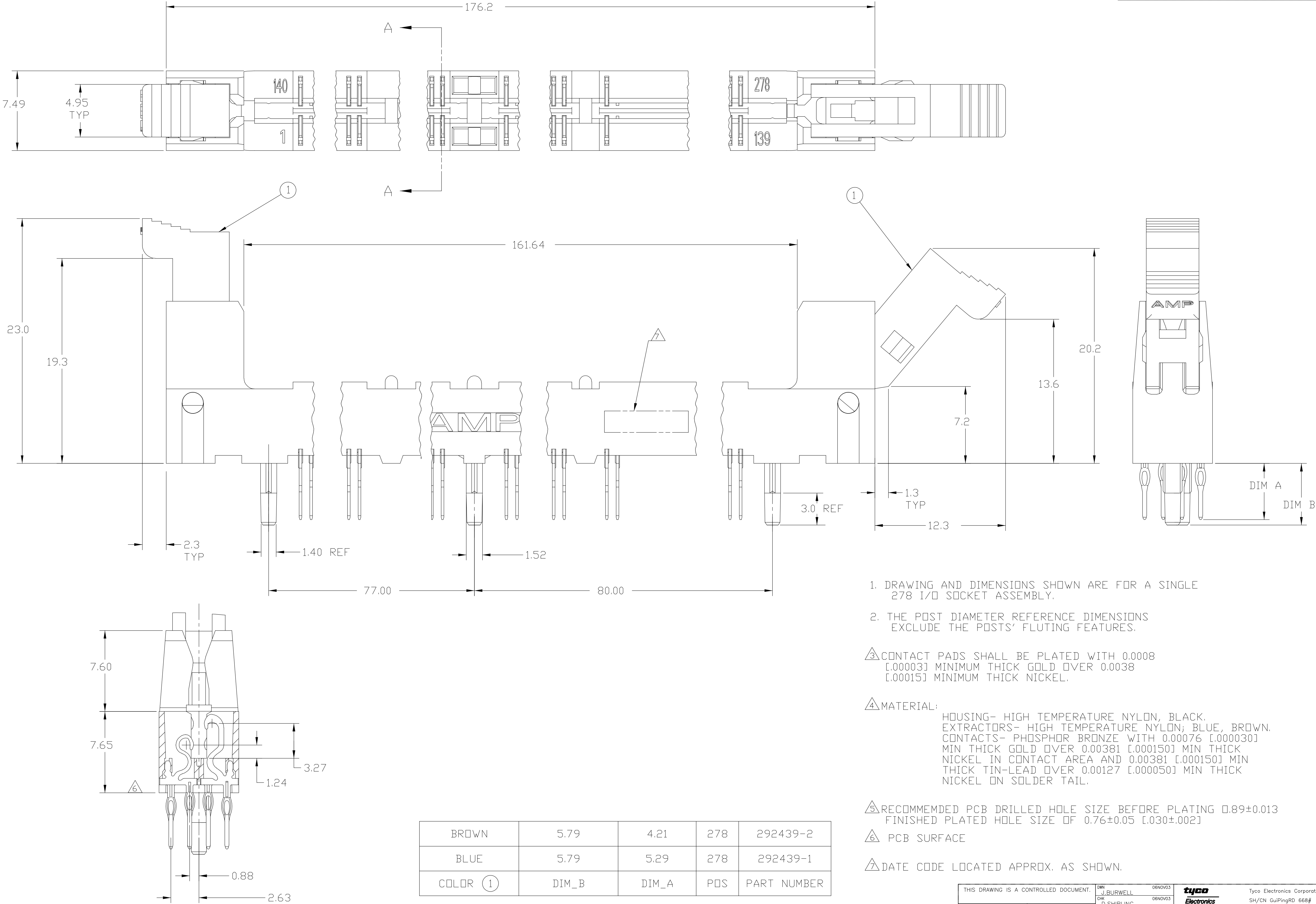




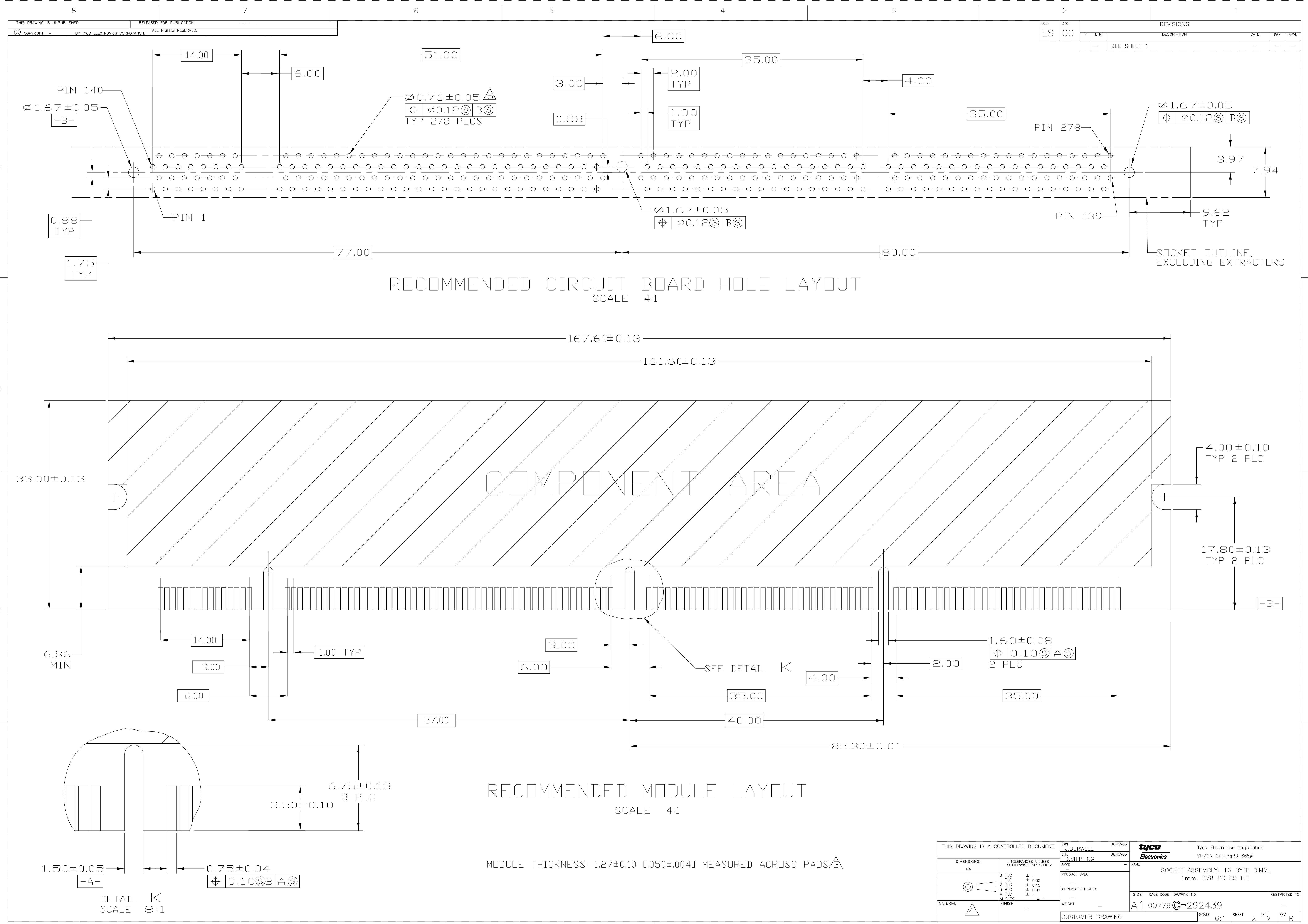
1. DRAWING AND DIMENSIONS SHOWN ARE FOR A SINGLE 278 I/O SOCKET ASSEMBLY.
2. THE POST DIAMETER REFERENCE DIMENSIONS EXCLUDE THE POSTS' FLUTING FEATURES.

3 CONTACT PADS SHALL BE PLATED WITH 0.0008 [0.0003] MINIMUM THICK GOLD OVER 0.0038 [0.0015] MINIMUM THICK NICKEL.

4 MATERIAL: HOUSING- HIGH TEMPERATURE NYLON, BLACK. EXTRACTORS- HIGH TEMPERATURE NYLON; BLUE, BROWN. CONTACTS- PHOSPHOR BRONZE WITH 0.00076 [0.00030] MIN THICK GOLD OVER 0.00381 [0.00150] MIN THICK NICKEL IN CONTACT AREA AND 0.00381 [0.00150] MIN THICK TIN-LEAD OVER 0.00127 [0.00050] MIN THICK NICKEL ON SOLDER TAIL.

- 5 RECOMMENDED PCB DRILLED HOLE SIZE BEFORE PLATING 0.89±0.013 FINISHED PLATED HOLE SIZE OF 0.76±0.05 [0.030±0.02]
- 6 PCB SURFACE
- 7 DATE CODE LOCATED APPROX. AS SHOWN.

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN J.BURWELL 06NOV03	Tyco Electronics Corporation	
CHK D.SHIRLING 06NOV03		NAME	SH/CN GuiPingRD 668#	
DIMENSIONS: MM		PRODUCT SPEC	SOCKET ASSEMBLY, 16 BYTE DIMM, 1mm, 278 PRESS FIT	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APPLICATION SPEC	RESTRICTED TO	
0 PLC ± -		SIZE	A1 00779	
1 PLC ± 0.30		WEIGHT	C=292439	
2 PLC ± 0.10		CUSTOMER DRAWING	SCALE 6:1 SHEET 1 OF 2 REV B	
3 PLC ± 0.01				
4 PLC ± -				
ANGLES ± -				
FINISH -				



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